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with Bushold and 3-STATE Outputs **General Description Features** The LVTH16501 is an 18-bit universal bus transceiver combining D-type latches and D-type flip-flops to allow $5V V_{CC}$ data flow in transparent, latched, and clocked modes.

Low Voltage 18-Bit Universal Bus Transceivers

Data flow in each direction is controlled by output-enable (OEAB and OEBA), latch-enable (LEAB and LEBA), and

clock (CLKAB and CLKBA) inputs. The LVTH16501 data inputs include bushold, eliminating

the need for external pull-up resistors to hold unused inputs.

The transceiver is designed for low voltage (3.3V) V_{CC} applications, but with the capability to provide a TTL interface to a 5V environment. The LVTH16501 is fabricated with an advanced BiCMOS technology to achieve high speed operation similar to 5V ABT while maintaining low power dissipation.

- Input and output interface capability to systems at
- Bushold data inputs eliminate the need for external pull-up resistors to hold unused inputs
- Live insertion/extraction permitted
- Power up/down high impedance provides glitch-free bus loading

March 2001

Revised March 2001

- Outputs source/sink –32 mA/+64 mA
- Functionally compatible with the 74 series 16501
- ESD Performance: Human-Body Model > 2000V Machine Model > 200V
 - Charged-Device Model > 1000V

Ordering Code:

FAIRCHILD

74LVTH16501

SEMICONDUCTOR

| Y4LVTH16501MEA MS56A 56-Lead Shrink Small Outline Package (SSOP), JEDEC MO-118, 0.300 Wide Y4LVTH16501MTD MTD56 56-Lead Thin Shrink Small Outline Package (TSSOP), JEDEC MO-153, 6.1mm Wide Devices also available in Tape and Reel. Specify by appending the suffix letter "X" to the ordering code. Devices also available in Tape and Reel. Specify by appending the suffix letter "X" to the ordering code. | Order Number | Package Number | Package Description |
|---|----------------|----------------|---|
| | '4LVTH16501MEA | MS56A | 56-Lead Shrink Small Outline Package (SSOP), JEDEC MO-118, 0.300 Wide |
| Devices also available in Tape and Reel. Specify by appending the suffix letter "X" to the ordering code. | 74LVTH16501MTD | MTD56 | 56-Lead Thin Shrink Small Outline Package (TSSOP), JEDEC MO-153, 6.1mm Wide |
| | | | |
| | | | |

Connection Diagram

| | • | | |
|-------------------|----|---------|--------------------|
| OEAB — | | , 56 | - GND |
| | 2 | 55 | - CLKAE |
| LEAB - | | | |
| A ₁ | 3 | 54 | — В ₁ |
| GND — | 4 | 53 | - GND |
| A ₂ — | 5 | 52 | — в ₂ |
| A3 — | 6 | 51 | — B ₃ |
| v _{cc} — | 7 | 50 | -v _{cc} |
| A4 — | 8 | 49 | — B ₄ |
| A ₅ — | 9 | 48 | — B ₅ |
| A ₆ — | 10 | 47 | — B ₆ |
| GND — | 11 | 46 | — GND |
| A ₇ — | 12 | 45 | — B ₇ |
| A ₈ — | 13 | 44 | — B ₈ |
| A ₉ — | 14 | 43 | — В ₉ |
| A ₁₀ - | 15 | 42 | — B ₁₀ |
| A ₁₁ - | 16 | 4 1 | — B _{1 1} |
| A ₁₂ - | 17 | 40 | — B ₁₂ |
| GND — | 18 | 39 | — GND |
| A ₁₃ - | 19 | 38 | — В ₁₃ |
| A14 | 20 | 37 | — В ₁₄ |
| A ₁₅ - | 21 | 36 | — B ₁₅ |
| v _{cc} — | 22 | 35 | -v _{cc} |
| A ₁₆ - | 23 | 34 | — B ₁₆ |
| A ₁₇ - | 24 | 33 | — В ₁₇ |
| GND — | 25 | 32 | - GND |
| A ₁₈ - | 26 | 31 | — B ₁₈ |
| OEBA - | 27 | 30 | - CLKBA |
| LEBA — | 28 | 29 | - GND |
| | | | |

Pin Descriptions

| Pin Names | Description |
|--|--|
| A ₁ -A ₁₈ | Data Register A Inputs/3-STATE Outputs |
| A ₁ –A ₁₈ B ₁ –B ₁₈ | Data Register B Inputs/3-STATE Outputs |
| CLKAB, CLKBA | Clock Pulse Inputs |
| LEAB, LEBA | Latch Enable Inputs |
| OEAB, OEBA | Output Enable Inputs |

Function Table (Note 1)

| | Inp | outs | | Output |
|------|------|------------|----|--|
| OEAB | LEAB | CLKAB | An | B _n |
| L | Х | Х | Х | Z |
| Н | Н | Х | L | L |
| н | Н | Х | н | н |
| н | L | \uparrow | L | L |
| н | L | Ŷ | н | н |
| н | L | Н | Х | B ₀ (Note 2) |
| н | L | L | Х | B ₀ (Note 2) B ₀ (Note 3) |

H = HIGH Voltage Level L = LOW Voltage Level X = Immaterial $\uparrow = LOW-to-HIGH Clock Transition$ Z = High Impedance

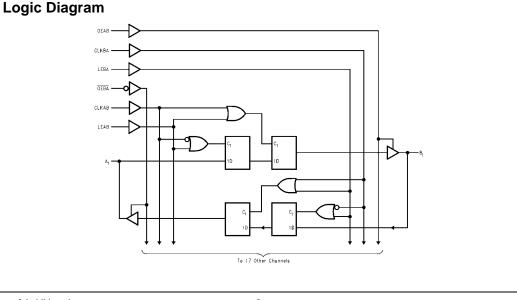
Note 1: A-to-B data flow is shown: B-to-A flow is similar but uses OEBA, LEBA, and CLKBA. OEBA is active LOW

Note 2: Output level before the indicated steady-state input conditions were established, provided that CLKAB was HIGH before LEAB went LOW. Note 3: Output level before the indicated steady-state input conditions were established.

Functional Description

For A-to-B data flow, the device operates in the transparent mode when LEAB is HIGH. When LEAB is LOW, the A data is latched if CLKAB is held at a HIGH or LOW logic level. If LEAB is LOW, the A bus data is stored in the latch/ flip-flop on the LOW-to-HIGH transition of CLKAB. Outputenable OEAB is active-HIGH. When OEAB is HIGH, the outputs are active. When OEAB is LOW, the outputs are in the high-impedance state.

Data flow for B to A is similar to that of A-to-B but uses OEBA, LEBA, and CLKBA. The output enables are complementary (OEAB is active-HIGH and OEBA is active-LOW).



| Symbol | Parameter | Value | Conditions | Units |
|-----------------|----------------------------------|--------------|---|-------|
| V _{CC} | Supply Voltage | -0.5 to +4.6 | | V |
| /1 | DC Input Voltage | -0.5 to +7.0 | | V |
| / ₀ | DC Output Voltage | -0.5 to +7.0 | Output in 3-STATE | V |
| | | -0.5 to +7.0 | Output in HIGH or LOW State (Note 5) | V |
| IK | DC Input Diode Current | -50 | V _I < GND | mA |
| Ж | DC Output Diode Current | -50 | V _O < GND | mA |
|) | DC Output Current | 64 | V _O > V _{CC} Output at HIGH State | |
| | | 128 | V _O > V _{CC} Output at LOW State | mA |
| сс | DC Supply Current per Supply Pin | ±64 | | mA |
| GND | DC Ground Current per Ground Pin | ±128 | | mA |
| STG | Storage Temperature | -65 to +150 | | °C |

Recommended Operating Conditions

| Symbol | Parameter | Min | Max | Units |
|-----------------|---|-----|-----|-------|
| V _{CC} | Supply Voltage | 2.7 | 3.6 | V |
| VI | Input Voltage | 0 | 5.5 | V |
| I _{OH} | HIGH-Level Output Current | | -32 | mA |
| I _{OL} | LOW-Level Output Current | | 64 | mA |
| T _A | Free-Air Operating Temperature | -40 | 85 | °C |
| Δt/ΔV | Input Edge Rate, $V_{IN} = 0.8V-2.0V$, $V_{CC} = 3.0V$ | 0 | 10 | ns/V |

Note 4: Absolute Maximum continuous ratings are those values beyond which damage to the device may occur. Exposure to these conditions or conditions beyond those indicated may adversely affect device reliability. Functional operation under absolute maximum rated conditions is not implied. Note 5: I_O Absolute Maximum Rating must be observed.

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DC Electrical Characteristics

| Querra la cal | Demonster | | V _{cc} | $T_A = -40^{\circ}C \text{ to } +85^{\circ}C$ | | Unite | 0 1141 |
|----------------------|-----------------------------|--------------|-----------------|---|------|-------|---------------------------------------|
| Symbol | Parameter | | (V) | Min | Max | Units | Conditions |
| V _{IK} | Input Clamp Diode Voltage | | 2.7 | | -1.2 | V | I _I = -18 mA |
| V _{IH} | Input HIGH Voltage | | 2.7-3.6 | 2.0 | | V | $V_0 \le 0.1V$ or |
| V _{IL} | Input LOW Voltage | | 2.7-3.6 | | 0.8 | v | $V_O \ge V_{CC} - 0.1V$ |
| V _{OH} | Output HIGH Voltage | | 2.7–3.6 | V _{CC} - 0.2 | | V | I _{OH} = -100 μA |
| | | | 2.7 | 2.4 | | V | I _{OH} = -8 mA |
| | | | 3.0 | 2.0 | | V | I _{OH} = -32 mA |
| V _{OL} | Output LOW Voltage | | 2.7 | | 0.2 | V | I _{OL} = 100 μA |
| | | | 2.7 | | 0.5 | V | I _{OL} = 24 mA |
| | | | 3.0 | | 0.4 | V | I _{OL} = 16 mA |
| | | | 3.0 | | 0.5 | V | I _{OL} = 32 mA |
| | | | 3.0 | | 0.55 | V | I _{OL} = 64 mA |
| I _{I(HOLD)} | Bushold Input Minimum Drive |) | 3.0 | 75 | | μΑ | V _I = 0.8V |
| | | | 3.0 | -75 | | μΑ | $V_{I} = 2.0V$ |
| I _{I(OD)} | Bushold Input Over-Drive | | 3.0 | 500 | | μΑ | (Note 6) |
| | Current to Change State | | 3.0 | -500 | | μΑ | (Note 7) |
| l _l | Input Current | | 3.6 | | 10 | μΑ | $V_{I} = 5.5V$ |
| | | Control Pins | 3.6 | | ±1 | μΑ | $V_I = 0V \text{ or } V_{CC}$ |
| | | | 3.6 | | -5 | μΑ | $V_I = 0V$ |
| | | Data Pins | 3.0 | | 1 | μΑ | $V_I = V_{CC}$ |
| I _{OFF} | Power Off Leakage Current | | 0 | | ±100 | μΑ | $0V \le V_I \text{ or } V_O \le 5.5V$ |
| I _{PU/PD} | Power up/down 3-STATE | | 0–1.5V | | ±100 | | V _O = 0.5V to 3.0V |
| | Output Current | | 0-1.5V | | ±100 | μΑ | $V_I = GND \text{ or } V_{CC}$ |
| I _{OZL} | 3-STATE Output Leakage Cu | rrent | 3.6 | | -5 | μΑ | $V_{0} = 0.0V$ |
| I _{OZH} | 3-STATE Output Leakage Cu | rrent | 3.6 | | 5 | μΑ | V _O = 3.6V |
| I _{OZH} + | 3-STATE Output Leakage Cu | rrent | 3.6 | | 10 | μΑ | $V_{CC} < V_O \le 5.5V$ |
| I _{CCH} | Power Supply Current | | 3.6 | | 0.19 | mA | Outputs HIGH |
| I _{CCL} | Power Supply Current | | 3.6 | | 5 | mA | Outputs LOW |
| I _{CCZ} | Power Supply Current | | 3.6 | 1 | 0.19 | mA | Outputs Disabled |
| I _{CCZ} + | Power Supply Current | | 3.6 | 1 | 0.19 | mA | $V_{CC} \le V_O \le 5.5 V,$ |
| | | | | | | | Outputs Disabled |
| ΔI _{CC} | Increase in Power Supply Cu | rrent | 3.6 | 1 | 0.2 | mA | One Input at V _{CC} – 0.6V |
| | (Note 8) | | | | | | Other Inputs at V _{CC} or GN |

Note 6: An external driver must source at least the specified current to switch from LOW-to-HIGH.

Note 7: An external driver must sink at least the specified current to switch from HIGH-to-LOW. Note 8: This is the increase in supply current for each input that is at the specified voltage level rather than V_{CC} or GND.

Dynamic Switching Characteristics (Note 9)

| | 0 | | | | | | |
|------------------|----------------------------------|-----------------|-----|---------------------|-----|-------|---|
| Symbol | Parameter | V _{cc} | | $T_A = 25^{\circ}C$ | | Units | Conditions |
| Cymbol | i urumeter | (V) | Min | Тур | Max | onito | $\textbf{C}_{\textbf{L}}=\textbf{50}~\textbf{pF},~\textbf{R}_{\textbf{L}}=\textbf{500}\Omega$ |
| V _{OLP} | Quiet Output Maximum Dynamic VOL | 3.3 | | 0.8 | | V | (Note 10) |

-0.8

V

(Note 10)

 V_{OLV}
 Quiet Output Minimum Dynamic V_{OL}
 3.3

 Note 9: Characterized in SSOP package. Guaranteed parameter, but not tested.

Note 10: Max number of outputs defined as (n). n-1 data inputs are driven 0V to 3V. Output under test held LOW.

| | | | $\textbf{T}_{\textbf{A}}=-\textbf{40}^{\circ}\textbf{C}$ to +85°C, $\textbf{C}_{\textbf{L}}=\textbf{50}$ pF, $\textbf{R}_{\textbf{L}}=\textbf{500}~\Omega$ | | | | |
|---------------------|---|---|--|------------|---------|------------|----------|
| Symbol | | Parameter | $V_{CC} = 3.3 \pm 0.3$ | | | | |
| | | | Min | Max | Min | Max | 1 |
| MAX | CLKAB or CLKBA to B or A | | 150 | | 150 | | MHz |
| PLH | Propagation Delay | | 1.3 | 5.1 | 1.3 | 5.6 | |
| PHL | Data to Outputs | | 1.3 | 4.7 | 1.3 | 5.3 | ns |
| PLH | Propagation Delay | | 1.5 | 5.5 | 1.5 | 6.1 | ns |
| PHL | LEBA or LEAB to B or A | | 1.5 | 5.1 | 1.5 | 5.7 | 113 |
| PLH | Propagation Delay | | 1.3 | 56 | 1.3 | 6.2 | ns |
| PHL | CLKBA or CLKAB to B or A | | 1.3 | 5.1 | 1.3 | 5.7 | |
| PZH | Output Enable Time | | 1.3 | 4.9 | 1.3 | 5.6 | ns |
| PZL | | | 1.3 | 5.4 | 1.3 | 6.2 | |
| PHZ | Output Disable Time | | 1.7 | 5.9 | 1.7 | 6.6 | ns |
| PLZ | | | 1.7 | 5.8 | 1.7 | 6.3 | |
| s | Setup Time | A before CLKAB | 2.1 | | 2.4 | | 1 – |
| | | B before CLKBA | 2.1 | | 2.4 | | ns |
| | | A or B before LE, CLK HIGH | 2.4 | | 1.6 | | |
| | | A or B before LE, CLK LOW | 2.4 | | 1.6 | | <u> </u> |
| t _H | Hold Time | A or B after CLK | 1.0 | | 1.0 | | ns |
| | | A or B after LE | 1.7 | | 1.7 | | |
| tw | Pulse Width | LE HIGH | 3.3 | | 3.3 | | ns |
| | Output to Output Skow (Note | CLK HIGH or LOW | 3.3 | 1.0 | 3.3 | 1.0 | |
| OSLH OSHL | Output to Output Skew (Note | | | 1.0 1.0 | | 1.0 1.0 | ns |
| Symbol | | Parameter Cond | | | Typical | | |
| | Input Capacitance $V_{CC} = 0V, V_1 = 0V \text{ or } V_1 = 0V \text{ or } V_2 = 0V$ | | | | | | Units |
| 21/0 Note 12: Ca | Input/Output Capacitance | $V_{CC} = 0V, V_1 = 0V \text{ or } V$ $V_{CC} = 3.0V, V_0 = 0V \text{ c}$ ncy f = 1 MHz, per MIL-STD-883, Method 30 | /cc or V _{CC} | | 4 | | pF pF |

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